Rectifier diodes ultrafast, rugged

Product specification

BYV72EF series

FEATURES

- Low forward volt drop
- Fast switching
- Soft recovery characteristic
- Reverse surge capability
- High thermal cycling performance

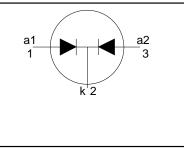
Dual, ultra-fast, epitaxial rectifier diodes intended for use as output

rectifiers in high frequency switched

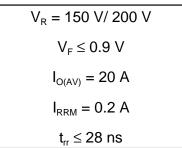
The BYV72EF series is supplied in the conventional leaded SOT199

- Isolated mounting tab

SYMBOL



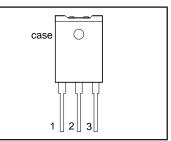
QUICK REFERENCE DATA



GENERAL DESCRIPTION PINNING

DESCRIPTION PIN 1 anode 1 (a) 2 cathode (k) 3 anode 2 (a) tab isolated





LIMITING VALUES

mode power supplies.

package.

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MA	۸X.	UNIT
		BYV72EF		-150	-200	
V _{RRM}	Peak repetitive reverse voltage		-	150	200	V
V _{RWM} V _R	Crest working reverse voltage Continuous reverse voltage	T _{hs} ≤ 125°C	-	150 150	200 200	V V
I _{O(AV)}	Average rectified output current (both diodes conducting) ¹	square wave $\delta = 0.5$; T _{bs} \leq 78 °C	-	2	0	A
I _{FRM}	Repetitive peak forward current		-	3	0	A
I _{FSM}	Non-repetitive peak forward	t = 10 ms	-	15	50	A
	current per diode	t = 8.3 ms sinusoidal; with reapplied	-	16	60	A
I _{RRM}	Repetitive peak reverse current		-	0	.2	A
I _{RSM}	Non-repetitive peak reverse current per diode	t _p = 100 μs	-	0	.2	A
T _{stg} T _j	Storage temperature Operating junction temperature		-40 -		50 50	°C ℃

¹ Neglecting switching and reverse current losses.

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ESD LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _c	Electrostatic discharge capacitor voltage	Human body model; C = 250 pF; R = 1.5 k Ω	-	8	kV

ISOLATION LIMITING VALUE & CHARACTERISTIC

 $T_{hs} = 25$ °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{isol}	Repetitive peak voltage from all three terminals to external heatsink	$R.H. \leq 65$ % ; clean and dustfree	-	-	2500	V
C _{isol}	Capacitance from T2 to external heatsink	f = 1 MHz	-	22	-	pF

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-hs}	Thermal resistance junction to heatsink Thermal resistance junction to ambient	both diodes conducting with heatsink compound without heatsink compound per diode with heatsink compound without heatsink compound in free air	- - - -	- - - 35	4.0 8.0 5.0 9.0 -	K/W K/W K/W K/W

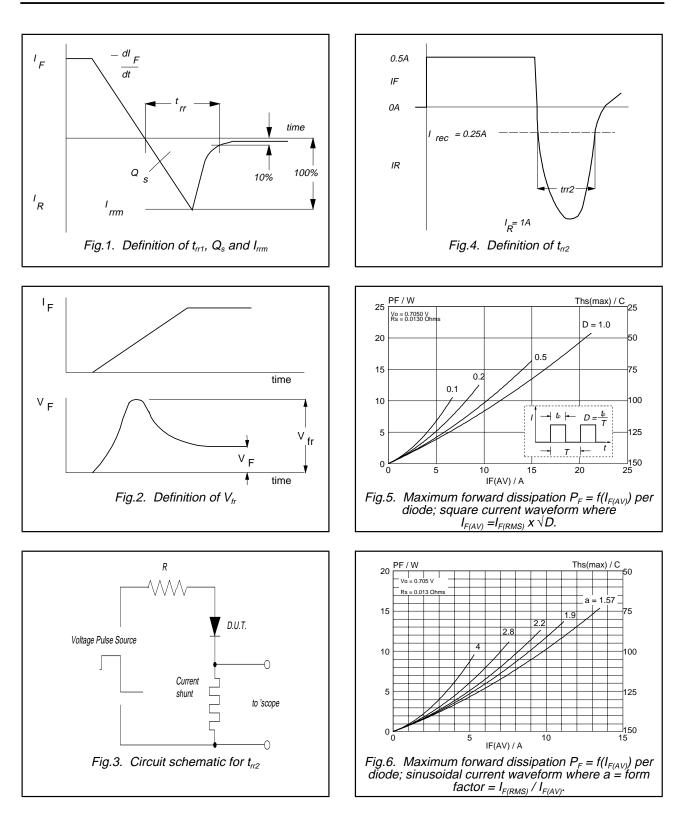
ELECTRICAL CHARACTERISTICS

characteristics are per diode at $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _F	Forward voltage	I _F = 15 A; T _i = 150°C	-	0.83	0.90	V
	-	$I_{\rm F} = 15 {\rm A}^{-1}$	-	0.95	1.05	V
		$I_{\rm F} = 30 {\rm A}$	-	1.00	1.20	V
I _R	Reverse current	$V_{R} = V_{RWM}; T_{j} = 100 \ ^{\circ}C$	-	0.5	1	mA
		$V_{R} = V_{RWM}$	-	10	100	μA
Qs	Reverse recovery charge	$I_{\rm F} = 2 \text{ A}; V_{\rm R} \ge 30 \text{ V}; -dI_{\rm F}/dt = 20 \text{ A}/\mu \text{s}$	-	6	15	μA nC
t _{rr1}	Reverse recovery time	$I_{\rm F} = 1 \text{ A}; V_{\rm R} \ge 30 \text{ V};$	-	20	28	ns
		-dl _⊧ /dt = 100 A/μs				
t _{rr2}	Reverse recovery time	$I_F = 0.5 \text{ A to } I_R = 1 \text{ A}; I_{rec} = 0.25 \text{ A}$	-	13	22	ns
t _{rr2} V _{fr}	Forward recovery voltage	$I_{F} = 1 \text{ A}; dI_{F}/dt = 10 \text{ Å}/\mu \text{s}$	-	1	-	V

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trr / ns

1000

100

10

1

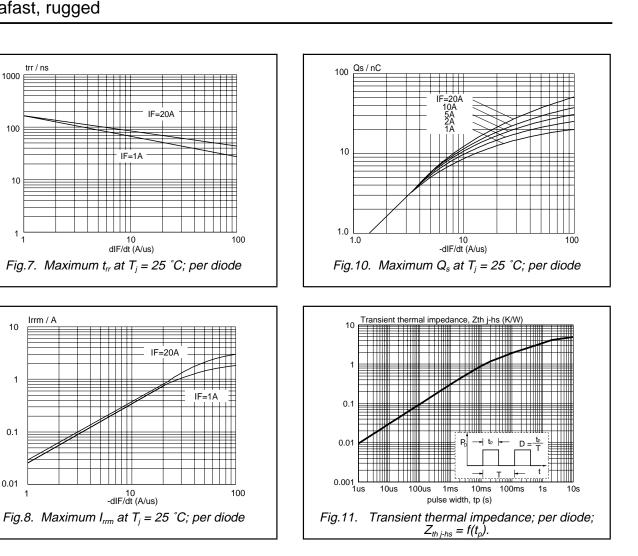
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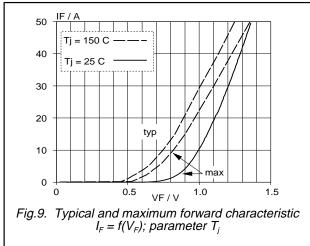
1

0.1

0.01

Irrm / A

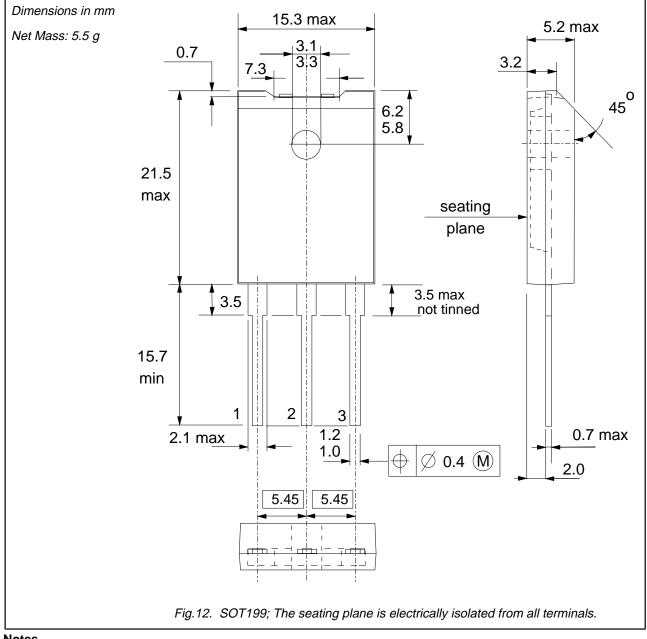




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MECHANICAL DATA



Notes 1. Refer to mounting instructions for F-pack envelopes. 2. Epoxy meets UL94 V0 at 1/8".

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DEFINITIONS

Data sheet status					
Dbjective specification This data sheet contains target or goal specifications for product development.					
Preliminary specification This data sheet contains preliminary data; supplementary data may be published la					
Product specification	This data sheet contains final product specifications.				
Limiting values					
or more of the limiting val operation of the device at	in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one lues may cause permanent damage to the device. These are stress ratings only and t these or at any other conditions above those given in the Characteristics sections of applied. Exposure to limiting values for extended periods may affect device reliability.				
••	ation is given, it is advisory and does not form part of the specification.				
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